



#### Annex B2 - Product environmental attributes Servers/Data Storage Products

The declaration may be published only when all rows and/or fields marked with \* are filled-in (N/A for not applicable). Additional information regarding each item may be found under P15.

Brand *	Lenovo	Logo	
Company name *	Lenovo		
Contact information *	Lenovo Global Environmental Affairs	1	Lenovo
e-mail address	Alvin L Carter		LCIIOVO
	alcarter@lenovo.com		
Internet site *	https://www.lenovo.com/us/en/sustainability-resources/		
Additional information	The latest version of this document can be found at:		
	http://www.lenovo.com/ecodeclaration		

	The company declares (based on product specification or test results based obtained from sample testing), that the product conforms to the statements given in this declaration.		
Type of product *	SERVER		
Commercial name *	Lenovo ThinkSystem SR670 V2		
Model number *	7Z22, 7Z23, 7D47		
Issue date *	2021-05-18		
Intended market *	☐ Global ☐ Europe ☐ Asia, Pacific & Japan ☐ Americas ☐ Other		
Additional information			

This is an uncontrolled copy when in printed form. Please refer to the contact information for the latest version.

#### About Annex B2

Annex B2 reflects Product environmental attributes relevant for Computers and Computer Monitors. The following items from the ECMA-370 Main body are not shown in the template:

P4.1 – P4.3 Consumable materials

P9.1 TEC and Print speed

P10.2 - P10.3 Chemical emissions from printing products

P11.1 - P11.3 Consumable materials for printing products

Model number * Issue date *	7Z22, 7Z23, 7D47 2021-05-18	Logo	Lenovo.
Product environ	mental attributes - Legal requirements		Requirement met

Product	environmental attributes - Legal requirements	Require	ment	met
Item	<u> </u>	Yes	No	N/A
P1	Hazardous substances and preparations	•		
P1.1*	Products do comply with current European RoHS Directive. (See legal reference and NOTE B1)	$\boxtimes$		
P1.2*	Products do not contain Asbestos (see legal reference).  Comment: Legal reference has no maximum concentration value.	$\boxtimes$		
P1.3*	Products do not contain Ozone Depleting Substances: Chlorofluorocarbons (CFC), hydrobromofluorocarbons (HBFC), hydrochlorofluorcarbons (HCFC), Halons, carbontetrachloride, 1,1,1-trichloroethane, methyl bromide (see legal reference). Comment: Legal reference has no maximum concentration values.			
P1.4*	Products do not contain more than; 0,005% polychlorinated biphenyl (PCB), 0,005% polychlorinated terphenyl (PCT) in preparations (see legal reference).			
P1.5*	Products do not contain more than 0,1% short chain chloroparaffins (SCCP) with 10-13 carbon atoms in the chain containing at least 48% per mass of chlorine in the SCCP (see legal reference).			
P1.6*	Parts with direct and prolonged skin contact do not release nickel in concentrations above 0,5 μg/cm²/week (see legal reference).  Comment: Max limit in legal reference when tested according to EN1811:2011-5.			
P1.7*	REACH Article 33 information about substances in articles is available at (add URL or mail contact): https://www.lenovo.com/us/en/Lenovo-REACH-SVHC-Disclosure			
P2	Batteries			
P2.1*	If the product contains a battery or an accumulator, the battery/accumulator is labeled with the disposal symbol. Information on proper disposal is provided in user manual. (See legal reference)	$\boxtimes$		
P2.2*	Batteries or accumulators do not contain more than 0,0005% of mercury or 0,002% of cadmium. (See legal reference)	$\boxtimes$		
P2.3*	Batteries and accumulators are readily removable. (See legal reference)	$\boxtimes$		
P2.4*	Documentation includes the number of cycles the (secondary) battery can withstand. (See legal reference)			$\boxtimes$
P2.5*	When internal batteries of a notebook computer cannot be "accessed and replaced by a nonprofessional user", the related text is present and legible on the external packaging (see legal reference)			$\boxtimes$
P3	Conformity verification & Eco design (ErP)			
P3.1*	The product is CE-marked to show conformance with applicable legal requirements (see legal reference). The Declaration of Conformity can be requested at: <a href="https://www.lenovo.com/us/en/compliance/eu-doc">https://www.lenovo.com/us/en/compliance/eu-doc</a> for EU and <a href="https://www.lenovo.com/us/en/compliance/uk-doc">https://www.lenovo.com/us/en/compliance/uk-doc</a> for UK			
P3.2*	The product complies with the Eco design requirements for energy-related products, (see legal reference).	$\boxtimes$		
	Required information is; Signer in item P15 or added to this document, available at: <a href="https://www.lenovo.com/us/en/compliance/eu-">https://www.lenovo.com/us/en/compliance/eu-</a>			
	doc#servers			
P5	Product packaging			
P5.1*	Packaging and packaging components do not contain more than 0,01% lead, mercury, cadmium an hexavalent chromium by weight of these together.	d 🔀		
P5.2*	The packaging materials are marked with abbreviations and numbers indicating the nature of the material(sused (see legal reference).	s) <u></u>		
P5.3*	The product packaging material is free from ozone depleting substances as specified in the Montreal Protoco (see legal reference).	ol 🔀		
	Comment: Legal reference has no maximum concentration values.			
P6	Treatment information			
P6.1*	Information for recyclers/treatment facilities is available (see legal reference).			

NOTE B1 Restriction applies to the homogeneous material, unless other specified and expressed in weight %. Stating "Yes" means that the product is compliant with the mandatory requirements.

Model nu	ımber *	7Z22, 7Z23, 7D47	Logo	Lon	Lenovo.		
Issue dat	te *	2021-05-18		Len	OVC	D <sub>tot</sub>	
Product	- Enviro	mental attributes - Market requirements (See General NOTE GN lonmental conscious design	pelow)	Require	ment	met	
Item		tory to fill in. Additional information regarding each item may be found under P14.		Yes	No	N/A	
P7		Disassembly, recycling					
P7.1*	Parts tha	t have to be treated separately are easily separable		$\boxtimes$			
P7.2*	Plastic m	naterials in covers/housing have no surface coating.					
P7.3*	Plastic p	arts > 100 g consist of one material or of easily separable materials.		$\boxtimes$			
P7.4*	Plastic p	arts > 25 g have material codes according to ISO 11469 referring ISO 1043-4.		$\boxtimes$			
P7.5	Plastic p	arts are free from metal inlays or have inlays that can be removed with commonly a	vailable tools.	$\boxtimes$			
P7.6*	Labels a	re easily separable. (This requirement does not apply to safety/regulatory labels).		$\boxtimes$			
	Product	lifetime					
P7.7*	Upgradir	g can be done e.g. with processor, memory, cards or drives					
P7.8*	Upgradir	g can be done using commonly available tools		$\boxtimes$			
P7.9	Spare pa	arts are available after end of production for: years					
P7.10	Service i	s available after end of production for: years					
	Material	and substance requirements					
P7.11*		cover/housing material type (e.g. plastics, metal, aluminum): type: <i>Metal</i> Material type: <i>Plastic</i> Materia	I type:				
P7.12	Insulation	n materials of external electrical cables are PVC free.				$\boxtimes$	
P7.13	Insulatio	n materials of internal electrical cables are PVC free.					
P7.14	External	plastic casing/cover parts > 25 g contain no more than 0,1% weight (1000 ppm) br	omine and 0,1°	%			

weight (1000 ppm) chlorine attributable to brominated flame retardants, chlorinated flame retardants, and polyvinyl chloride or 0,3% weight (3000 ppm) bromine and 0,3% weight (3000 ppm) chlorine in parts containing

Printed circuit boards, PCBs (without components) are low halogen: all PCBs > 25 g are low halogen

Alt. 1: Chemical specifications of flame retardants in printed circuit boards > 25 g (without components):

Alt. 2: Chemical specifications of flame retardants in printed circuit boards (without components) > 25 g

(See NOTE B4)

In plastic parts > 25 g, flame retardant substances/preparations above 0,1% are used which have been

and Hazard statements:

Of total plastic parts' weight > 25 g, the postconsumer recycled plastic material content (calculated as

(See note B5)

Alt. 2: Chemical specifications of flame retardants in plastic parts > 25 g according ISO 1043-4:

Alt. 1: Flame retarded plastic parts > 25 g contain the following flame retardant substances/preparations in

Flame retarded plastic parts > 25 g in covers / housings are marked according ISO 1043-4:

TBBPA (additive) \_\_\_\_, TBBPA (reactive) \_\_\_\_ (See NOTE B3), Other: chemical name:

Postconsumer recycled plastic material content is used in the product (See Note B6):

more than 25% post-consumer recycled content.

as defined in IEC 61249-2-21. (See <sup>5</sup>NOTE B2)

, CAS #:

CAS #:

CAS #:

The source(s) for these classifications is/are found at (add URL(s)):

If YES; at least one of the two alternatives below shall be answered;

a percentage of total plastic by weight) is

The weight of recycled material is

P7.15

P7.16

P7.17

P7.18

P7.19

P7.20\*

or b)

Marking:

according ISO 1043-4:

Chemical name:
 Chemical name:

concentrations above 0,1%:
1. Chemical name: , 0

assigned the following Risk phrases;

GENERAL NOTE Standard references should direct to the latest version of a standard. If an older version of a standard is used, section P15 shall be used for explanation.

NOTE B2 IEC 61249-2-21 defines maximum limits of 900 ppm for each of the substances chlorine and bromine and a maximum limit of 1500ppm of these substances combined. The standard does not address fluorine, iodine and astatine which are included in the group of halogens.

NOTE B3 and B4 A Guidance document on Chemical substances is available; see <a href="http://www.ecma-international.org/publications/standards/Ecma-370.htm">http://www.ecma-international.org/publications/standards/Ecma-370.htm</a>.

NOTE B5 If a certain substance has been assigned a certain risk phrases / hazard statement in the referenced source, this does not necessarily mean the substance has been tested for all of the hazards referred to by a certain customer.

NOTE B6 Applies to a product containing plastic parts whose combined weight exceeds 100 g with the exception of printed circuit boards, cables, connectors and electronic components and bio-based plastic material.

Model number *	7Z22, 7Z23, 7D47	Logo	Lenovo		
Issue date *	2021-05-18		Len		TH
Product environn	nental attributes - Market requirements (continued)		Requir	emen	t met
Item			Yes	No	N/A

D7.04*		ubstance requirements (		OTE DZ	<u> </u>			_
P7.21*	Biobased plasti	c material content is used	in the product (See N	OTE B7):			$\boxtimes$	
	a) Of total pla	one of the two alternatives astic parts' weight > 25 g, to by weight) is %.			ated as a percentage of			
		t of the biobased plastic m	naterial is a.					
P7.22*	Light sources a	re free from mercury, i.e. I ed specify: Number of lam	ess than 0,1 mg/lamp	um mercury content p	er lamp: mg			
P7.23*		des an integral display, the						$\square$
P8	Batteries	ioo an intogral dioplay, are	total moroary conton	in the integrated displ	iay. iiig			
P8.1*		al composition: Lithium M	langanese Dioxide					П
P9		mption (See NOTE B8)	angunees brownes					
P9.1		the following power levels	s or energy consumption	ons are reported:				
Energy mo		Power level at 100 V AC	Power level at 115 V AC	Power level at 230 V AC	Reference/Standard modes and test metho		ergy	
Peak (On-	max)	W	W	W	Full load			
Cotomor								
Categor EPS No-loa		W	W	I w	1			
	ower supply /	VV	VV	VV				
	gged in the wall							
	isconnected fron	ı						
the product	t.)							
PTEC *	ti-	W	W	W				$\boxtimes$
ETEC *	ergy Consumptio	n kWh/year	kWh/year	kWh/year				
_	ergy Consumptio		kvvn/year	kvvn/year				$\boxtimes$
		iency Level (International	Efficiency Marking Pro	otocol) * :				$\boxtimes$
Display res	,	megapixels	, ,	,				X
' '	e to enter energy	0 1	PS					
P9.2*		out the energy save function		product			_	∺
P9.3			on is provided with the	product.				
P9.3		cy class (monitors only):			1		-	
P10	Emissions	n – Declared according to	ISO 9296 (See NOTE	: R0)				
P10.1	Mode	Mode description	100 0200 (000 110 12		nit A-weighted sound powe	er level.	Lwas	(B)
	Idle	* SXM Configuration		* 7.1	д р		- VVA,C	
	Operation	* SXM Configuration (50% fan duty)		* 8.3				
	Idle	* GPU-Typical		* 7.1				
	Operation	* GPU Rich Configuration (45% fan duty)		* 8.1				
	Idle	* GPU-Max		* 7.9				
	Operation	(60% fan duty)						
	Other mode $Declared A$ -weighted sound pressure level (dB) (operator position desktop – idle) $L_{p \text{Am}}$							
	Other mode $Declared A$ -weighted sound pressure level (dB) $L_{pAm}$ (operator position desktop – operating)							
	Measured acco	· =	ECMA-74 (only if not covered by	/ ECMA-74)				
	Electromagne		()	= 3 /				
P10.4		ay meets the requirement	for low frequency elec	ctromagnetic fields of t	he following voluntary			

NOTE B7 The following is to be excluded from the calculation of percentage: printed circuit boards, labels, cables, connectors and electronic components and postconsumer recycled plastic

NOTE B8 A Guidance document on Energy Efficiency is available; see <a href="http://www.ecma-international.org/publications/standards/Ecma-370.htm">http://www.ecma-international.org/publications/standards/Ecma-370.htm</a>

NOTE B9 A Guidance document on Acoustic Noise is available; see <a href="http://www.ecma-international.org/publications/standards/Ecma-370.htm">http://www.ecma-international.org/publications/standards/Ecma-370.htm</a>

Model nur	el number * 7Z22, 7Z23, 7D47 Logo Lenovo		<b>V</b>					
Issue date	*	2021-05-18				Lelio	VO.	
Product	environn	nental attributes	- Market require	ements (continued)		Require	ment	met
Item						Yes	No	N/A
P12		nics for computing						
P12.1*	The disp	lay meets the ergon	omic requirements	s of ISO 9241-307 for visual display	technologies.			$\boxtimes$
P12.2*	The phys	sical input device me	ets the requireme	ents of ISO 9995 and ISO 9241-410.				$\boxtimes$
P13		ng and documenta						
P13.1*	Product Product	packaging material t packaging material t	ype(s): <i>Paper - Co</i> ype(s): <i>Plastic - F</i>	orrugated Double wall weight (kg): orrugated single wall weight (kg): PE (polyethylene) weight (kg): 0.006 PP (polypropylene) weight (kg):	: <b>0.265</b> 6			
P13.2*	Product	plastic primary pack	aging is free from	PVC.		$\boxtimes$		
P13.3*		luct primary corruga er recovered fiber co		ackaging, specify the contained per	rcentage of minimum	post-		
P13.4*		media for user and p ronic, ⊠Paper, □		ation (tick box):				
P13.5	Ùser and	only complete this ito I product documenta ease specify:						
	Totally c	hlorine-free						
	Elementa	al chlorine-free						
	Processe	ed chlorine-free						
P14		ry programs						
P14.1	The proc	luct meets the require	rements of the follo	owing voluntary program(s):				
	Eco-labe	l: ENERGY STAR	Eco-label:	Eco-label:	Eco-label:			
	Eco-labe	l:	Eco-label:	Eco-label:	Eco-label:			
P15		nal information (Sec						
P9				; description of the tested produc				
	the information	rmation contained : 's knowledge avail	in this document able at the time on on provided here	guarantees, assurances or warran i. All information provided by supportion of the supplier shall have a supplier shall have a supproximate and provided for inter- tion.	olier in this documer have no obligation to	nt is provided in o update such	based	on
P9				rs for the latest information:				
	https://v	ww.energystar.go	v/products/data	center equipment/enterprise serv	<u>vers</u>			

NOTE B10 Additional lines may be inserted to declare further items, by positioning the cursor at the far right of the row and hitting the <Enter> key.

## Legal references Europe Annex B2

Reference	Declaration item
Directive 2011/65/EU (RoHS Directive)*  * Specific exemptions apply for certain products and applications.	P1.1, P3.1
Regulation (EC) 1907/2006 (REACH Regulation), annex XVII	P1.2, P1.4, P1.6, P1.7
Regulation (EC) 2037/2000, 2038/2000, 2039/2000 (Marketing and use of Ozone layer depleting substances)	P1.3, P5.3
Norwegian regulation relating to restrictions on the use of certain dangerous chemicals 20.12.2002	P1.5
Directive 2006/66/EC (Battery and accumulators Directive), as amended.*  * These provisions shall not apply where, for safety, performance, medical or data integrity reasons, continuity of power supply is necessary and requires a permanent connection between the appliance and the battery or accumulator.	P2.1, P2.2, P2,3, P8.1
Directive 2014/35/EU (Low Voltage Directive)	P3.1
Directive 2014/30/EU (EMC Directive)	P3.1
Directive 2014/53/EU (RE Directive)	P3.1
Regulation (EC) 801/2013 amending Regulation (EC) No 1275/2008 with regard to ecodesign requirements for standby, off mode electric power consumption of electrical and electronic household and office equipment, and amending Regulation (EC) No 642/2009 with regard to ecodesign requirements for televisions	P3.1, P3.2
Commission Regulation (EC) No 278/2009 of 6 April 2009 implementing Directive 2005/32/EC of the European Parliament and of the Council with regard to ecodesign requirements for no-load condition electric power demand and average active efficiency of external power supplies	P3.1, P3.2, P9.1
COMMISSION REGULATION (EU) No 617/2013 of 26 June 2013 implementing Directive 2009/125/EC of the European Parliament and of the Council with regard to ecodesign requirements for computers and computer servers	P2.4, P2.5, P3.1, P3.2, P7.23, P9.1
Regulation (EC) No 1272/2008 (CLP Regulation)	P7.19
Directive 2004/12/EC (Packaging Directive)	P5.1
Decision 97/129/EC (Secondary packaging legislation)	P5.2
Directive 2012/19/EU (WEEE directive)	P6.1
Implementing Regulation (EU) 2019/290 establishing the format for registration and reporting of producers of electrical and electronic equipment to the register.	
Commission Implementing Regulation 2017/699 establishing a common methodology for the calculation of the weight of electrical and electronic equipment (EEE) placed on the national market in each Member State and a common methodology for the calculation of the quantity of waste electrical and electronic equipment (WEEE) generated by weight in each Member State.	

# Lenovo ErP Lot9 Information Sheet - Servers & Storage Products-

As required by COMMISSION REGULATION (EU) 2019/424 of 15 March 2019 laying down ecodesign requirements for servers and data storage products pursuant to Directive 2009/125/EC of the European Parliament and of the Council and amending Commission Regulation (EU) No 617/2013. (ErP Lot9)

#### Products scope of this sheet: Servers & storage products

This document is only valid in connection with the IT Eco Declaration of the specific Product.

#### **SERVERS**

#### General information

Commercial name (3.1 (b))	Lenovo ThinkSystem SR670 V2	Logo	
Contact Address (3.1 (b) )	7001 Development Dr. Building 7		
	Morrisville, NC 27560		
	United States		Lenovo
Model Number (3.1 (c) )	7Z22, 7Z23, 7D47		
Issue Date	2021-05-18		
Additional information			

Product 6	environmental attributes (EU) 2019/424 – Annex II points 3.1 and 3.3
1.a	Is the product consider to be in scope of ErP Lot 9 in scope out of scope, product is out of scope as:
1.b	Server type Rack Server High Performance Computing (HPC)
(3.1 (a))	Tower Server Multi Node Server
	Blade Server Data Storage product (Please go to "DATA STORAGE PRODUCTS" section
1.c (3.1 (d))	Year of manufacture: 2021
1.d (3.1 (p))	Product model part of a server product family? No Yes List of all model configurations that are represented by the model: https://lenovopress.com/lp1393-thinksystem-sr670-v2-server
1.e	Information on the secure data deletion functionality
(3.1 (n))	(a) instructions on how to use the functionality:
	2 methods are provided to use the functionality.
	Use a command line tool to do the secure data deletion on the remote target system via boot up a customized     Linux OS on it.
	Eg: OneCli.exe serase –bmc USERID:PASSWORD@xx.xx.xx.xxsftp root:password@xx.xxx.xx.xx:/home –log 5
	2) Use BoMC to create a full functions bootable media, start the media and choose secure erase from the text menu.
	(b) techniques used: OS tools under Linux -> Standard Linux Open Source tool
	(c) supported secure data deletion standard (if any):
	Secure Erase/block Erase/Crypto Erase, Sanitize
	OR - Reference to other information: Hdparm: https://en.wikipedia.org/wiki/Hdparm
	Nvme-format: https://www.mankier.com/1/nvme-format
	sg_sanitize: https://www.systutorials.com/docs/linux/man/8-sg_sanitize/
	scrub: https://www.systutorials.com/docs/linux/man/1-scrub/
	storcli: https://docs.broadcom.com/docs-and-downloads/raid-controllers/raid-controllers-common-iles/StorCLI RefMan revf.pdf
1.f (3.1 (o))	Blade servers? No Yes
` ', ','	list of recommended combinations with compatible chassis:
Recycling 2.a	Indicative weight range at component level, of the (a) Cobalt in the batteries (b) Neodymium in the HDDs
(3.3 (a))	following critical raw materials:  (a) Cobalt in the batteries  (b) Neodymidin in the hbbs
	between 5 g and 25 g between 5 g and 25 g
	above 25 g
2.b	Instructions on the disassembly operations
(3.3 (b))	<ul><li>(a) the type of operation;</li><li>(b) the type and number of fastening technique(s) to be unlocked;</li><li>(c) the tool(s) required.</li></ul>
	OR - Reference to other information:  https://thinksystem.lenovofiles.com/help/topic/SR670V2/sr670v2 maintenance manual.pdf

2.c	Firmware
	Reference to information on last available firmware:
	https://datacentersupport.lenovo.com/cn/en/products/servers/thinksystem/sr670v2/7z23/downloads/driver-list/
Additiona	l information

### Server family specific information Family 1

Madala	no. / name	1 - 2 CPU populated family			
Model number(s) / Description		Standard or low-end performance configuration:			
(3.1 (c) )		Processor(Minimum result of core count * frequency in family): Intel(R) Xeon(R) Silver 4309Y * 2,			
				ty in family) * 16, PSU: 1800W * 4, Lenovo	
		i350-T4 1Gbps 4-port Ethernet *1			
		High-end performance configuration:  Processor(Maximum result of core count * frequency in family): Intel® Xeon® 8380 * 2, Storage:			
			E QSFP56 2-port PCle 4 Etheri	00W * 4, 10/25GbE SFP28 2-port OCP	
		You can refer to	2 Q31 F 30 2-port F Cle 4 Etheri	net Adapter 1	
		https://www.plugloadsolutions.com/80PlusPowerSuppliesDetail.aspx?id=49&type=1,			
Addition	nal information	along with			
			393-thinksystem-sr670-v2-ser		
		https://dcsc.lenovo.com/#/configuration/cto/7Z23CTO1WW?hardwareType=server			
Product environmental attributes (EU) 2019/424 – Annex II points 3.1 and 3.3					
F1.a	PSU efficiency at 10 % (if applicable), 20 %, 50 % and 100 % of rated output power				
(3.1 (e))	(expressed in % and rounded to the first decimal place): Multi-output Single-output				
	· / — · · — · ·				
	Standard or low-end performance configuration(s):				
	10% <b>91.66</b> 20% <b>93</b>	87 50% 95.01 100% 94.10 Average 94.32			
	High and performance	ce configuration(s):			
	High-end performance configuration(s): 10% 92.38 20% 94.75 50% 95.15 100% 93.27 Average 94.39				
	1070 32:00 2070 34	170 0070 30:10 10070 30:21	Average 54.00		
F1.b	Power factor at 50 % of the rated load level		standard or low-end performance high-end performance		
(3.1 (f))	(rounded to three de		configuration: 0.990	configuration: 1.000	
F1.c	PSU rated power output		standard or low-end performance high-end performance		
(3.1 (g))	(in Watts rounded to	the nearest integer)	configuration: 1800	configuration: 2400	
	internal note:	yer product femily all DCI is offered in a conver			
	product family shall be reported w	ver product family, all PSUs offered in a server vith the information specified in (e) and (f)			
F1.d	idle state power		standard or low-end performar	nce high-end performance	
(3.1 (h))		ed to the first decimal place)	configuration: 160.5	configuration: 645.2	
F1.e	List of all component	ts for additional idle power allow	ances		
(3.1 (i))		standard o	r low-end performance	high-end performance	
		configuration		configuration:	
	CPU Performance		et (10 × PerfCPU W)	1 Socket	
			Ct (10 ~ 1 choi o vv)		
ts		V 2 Cook	at /7 × DarfCDLLM/\	2 Cooket	
ll ueu	Additional DCLL		et (7 × PerfCPU W)	2 Socket	
HDD #		No #: 3	et (7 × PerfCPU W)	Yes #: 3	
ıstı	Additional PSU HDD	No #: 3 Yes #: 2	et (7 × PerfCPU W)	Yes #: 3 No #: 0	
adjustı g	HDD SDD	No #: 3 Yes #: 2 No #: 0	,	Yes #: 3 No #: 0 Yes #: 2	
es adjustı sting	HDD SDD Additional memory	No #: 3 Yes #: 2 No #: 0 Yes #: 252	,	Yes #: 3 No #: 0 Yes #: 2 Yes #: 2044GB	
ances adjusti j testing	HDD SDD Additional memory Additional buffered DDF	No #: 3 Yes #: 2 No #: 0 Yes #: 252 R channel No #: 0	,	Yes #: 3 No #: 0 Yes #: 2 Yes #: 2044GB No #: 8	
owances adjusti ring testing	HDD SDD Additional memory	No #: 3 Yes #: 2 No #: 0 Yes #: 252 R channel No #: 0	GB	Yes #: 3 No #: 0 Yes #: 2 Yes #: 2044GB No #: 8	
r allowances adjustments during testing	HDD SDD Additional memory Additional buffered DDF	No #: 3 Yes #: 2 No #: 0 Yes #: 252 R channel No #: 0  1 Gb/s:	GB No Allowance	Yes #: 3 No #: 0 Yes #: 2 Yes #: 2044GB No #: 8	
Ver	HDD SDD Additional memory Additional buffered DDF	No #: 3 Yes #: 2 No #: 0 Yes #: 252 R channel No #: 0 none 1 1 Gb/s:	GB  No Allowance 2,0 W/Active Port	Yes #: 3 No #: 0 Yes #: 2 Yes #: 2044GB No #: 8	
Ver	HDD SDD Additional memory Additional buffered DDF	No #: 3 Yes #: 2 No #: 0 Yes #: 252 R channel No #: 0 none 1 1 Gb/s:	GB No Allowance	Yes #: 3 No #: 0 Yes #: 2 Yes #: 2044GB No #: 8	
idle power allowances adjust during testing	HDD SDD Additional memory Additional buffered DDF	No #: 3 Yes #: 2 No #: 0 Yes #: 252 R channel No #: 0 none < 1 Gb/s:	GB  No Allowance 2,0 W/Active Port	Yes #: 3 No #: 0 Yes #: 2 Yes #: 2044GB No #: 8	
Ver	HDD SDD Additional memory Additional buffered DDF	No #: 3  Yes #: 2  No #: 0  Yes #: 252  R channel  No #: 0  none  < 1 Gb/s:  > 1 Gb/s a  ≥ 10 Gb/s	GB  No Allowance 2,0 W/Active Port and < 10 Gb/s: 4,0 W/Active Port	Yes #: 3 No #: 0 Yes #: 2 Yes #: 2044GB No #: 8	
Ver	HDD SDD Additional memory Additional buffered DDF	No #: 3  Yes #: 2  No #: 0  Yes #: 252  R channel  No #: 0  none  < 1 Gb/s:	GB  No Allowance 2,0 W/Active Port and < 10 Gb/s: 4,0 W/Active Port and < 25Gb/s: 15,0 W/Active Port	Yes #: 3 No #: 0 Yes #: 2 Yes #: 2044GB No #: 8  none	
idle power	HDD SDD Additional memory Additional buffered DDF Additional I/O devices	No #: 3  Yes #: 2  No #: 0  Yes #: 252  R channel  No #: 0  none  < 1 Gb/s:	No Allowance 2,0 W/Active Port and < 10 Gb/s: 4,0 W/Active Port and < 25Gb/s: 15,0 W/Active Port and < 50Gb/s: 20,0 W/Active Port 26,0 W/Active Port	Yes #: 3 No #: 0 Yes #: 2 Yes #: 2044GB No #: 8  none	
Ver	HDD SDD Additional memory Additional buffered DDF Additional I/O devices	No #: 3  Yes #: 2  No #: 0  Yes #: 252  R channel  No #: 0  none  <1 Gb/s:  ≥1 Gb/s:  ≥10 Gb/s  ≥25 Gb/s  ≥50 Gb/s	No Allowance 2,0 W/Active Port and < 10 Gb/s: 4,0 W/Active Port and < 25Gb/s: 15,0 W/Active Port and < 50Gb/s: 20,0 W/Active Port 26,0 W/Active Port standard or low-end performan	Yes #: 3  No #: 0  Yes #: 2  Yes #: 2044GB  No #: 8  □ none □ <1 Gb/s: No Allowance □ =1 Gb/s: 2,0 W/Active Port □ >1 Gb/s and <10 Gb/s: 4,0 W/Active Port □ ≥ 10 Gb/s and < 25Gb/s: 15,0 W/Active Port □ ≥ 25 Gb/s and < 50Gb/s: 20,0 W/Active Port □ ≥ 50 Gb/s 26,0 W/Active Port nce high-end performance	
idle power	HDD SDD Additional memory Additional buffered DDF Additional I/O devices	No #: 3   Yes #: 2   No #: 0   Yes #: 252   R channel	No Allowance 2,0 W/Active Port and < 10 Gb/s: 4,0 W/Active Port and < 25Gb/s: 15,0 W/Active Port and < 50Gb/s: 20,0 W/Active Port 26,0 W/Active Port	Yes #: 3  No #: 0  Yes #: 2  Yes #: 2044GB  No #: 8  none  < 1 Gb/s: No Allowance = 1 Gb/s: 2,0 W/Active Port > 1 Gb/s and < 10 Gb/s: 4,0 W/Active Port ≥ 10 Gb/s and < 25Gb/s: 15,0 W/Active Port ≥ 25 Gb/s and < 50Gb/s: 20,0 W/Active Port  > 25 Gb/s 26,0 W/Active Port  high-end performance configuration: 1024.7	
F1.f (3.1 (j))	HDD SDD Additional memory Additional buffered DDF Additional I/O devices  maximum power (in Watts and rounder	No #: 3   Yes #: 2   No #: 0   Yes #: 252   R channel	No Allowance 2,0 W/Active Port and < 10 Gb/s: 4,0 W/Active Port and < 25Gb/s: 15,0 W/Active Port and < 50Gb/s: 20,0 W/Active Port 26,0 W/Active Port standard or low-end performanconfiguration: 334.4 standard or low-end performanconfiguration or low-end performanconfiguration or low-end performanconfiguration or low-end performanconfiguration.	Yes #: 3  No #: 0  Yes #: 2  Yes #: 2044GB  No #: 8  □ none □ <1 Gb/s: No Allowance □ = 1 Gb/s: 2,0 W/Active Port □ > 1 Gb/s and < 10 Gb/s: 4,0 W/Active Port □ ≥ 10 Gb/s and < 25Gb/s: 15,0 W/Active Port □ ≥ 25 Gb/s and < 50Gb/s: 20,0 W/Active Port □ ≥ 50 Gb/s 26,0 W/Active Port □ configuration: 1024.7  nce high-end performance configuration: 1024.7	
F1.f (3.1 (j)) F1.g	HDD SDD Additional memory Additional buffered DDF Additional I/O devices  maximum power (in Watts and rounded operating condition of	No #: 3   Yes #: 2   No #: 0   Yes #: 252   R channel	No Allowance 2,0 W/Active Port and < 10 Gb/s: 4,0 W/Active Port and < 25Gb/s: 15,0 W/Active Port and < 50Gb/s: 20,0 W/Active Port 26,0 W/Active Port standard or low-end performat configuration: 334.4 standard or low-end performat configuration:	Yes #: 3  No #: 0  Yes #: 2  Yes #: 2044GB  No #: 8  □ none □ <1 Gb/s: No Allowance □ = 1 Gb/s: 2,0 W/Active Port □ > 1 Gb/s and < 10 Gb/s: 4,0 W/Active Port □ ≥ 10 Gb/s and < 25Gb/s: 15,0 W/Active Port □ ≥ 25 Gb/s and < 50Gb/s: 20,0 W/Active Port □ ≥ 50 Gb/s 26,0 W/Active Port nce high-end performance configuration: 1024.7  high-end performance configuration:	
F1.f (3.1 (j)) F1.g	HDD SDD Additional memory Additional buffered DDF Additional I/O devices  maximum power (in Watts and rounded operating condition of	No #: 3   Yes #: 2   No #: 0   Yes #: 252   R channel	No Allowance 2,0 W/Active Port and < 10 Gb/s: 4,0 W/Active Port and < 25Gb/s: 15,0 W/Active Port and < 50Gb/s: 20,0 W/Active Port 26,0 W/Active Port standard or low-end performanconfiguration: 334.4 standard or low-end performanconfiguration or low-end performanconfiguration or low-end performanconfiguration or low-end performanconfiguration.	Yes #: 3  No #: 0  Yes #: 2  Yes #: 2044GB  No #: 8  □ none □ <1 Gb/s: No Allowance □ = 1 Gb/s: 2,0 W/Active Port □ > 1 Gb/s and < 10 Gb/s: 4,0 W/Active Port □ ≥ 10 Gb/s and < 25Gb/s: 15,0 W/Active Port □ ≥ 25 Gb/s and < 50Gb/s: 20,0 W/Active Port □ ≥ 50 Gb/s 26,0 W/Active Port □ configuration: 1024.7  nce high-end performance configuration: 1024.7	
F1.f (3.1 (j)) F1.g	HDD SDD Additional memory Additional buffered DDF Additional I/O devices  maximum power (in Watts and rounded operating condition of	No #: 3   Yes #: 2   No #: 0   Yes #: 252   R channel	No Allowance 2,0 W/Active Port and < 10 Gb/s: 4,0 W/Active Port and < 25Gb/s: 15,0 W/Active Port and < 50Gb/s: 20,0 W/Active Port 26,0 W/Active Port standard or low-end performat configuration: 334.4 standard or low-end performat configuration:	Yes #: 3  No #: 0  Yes #: 2  Yes #: 2044GB  No #: 8  □ none □ <1 Gb/s: No Allowance □ = 1 Gb/s: 2,0 W/Active Port □ > 1 Gb/s and < 10 Gb/s: 4,0 W/Active Port □ ≥ 10 Gb/s and < 25Gb/s: 15,0 W/Active Port □ ≥ 25 Gb/s and < 50Gb/s: 20,0 W/Active Port □ ≥ 50 Gb/s 26,0 W/Active Port nce high-end performance configuration: 1024.7  high-end performance configuration:	
F1.f (3.1 (j)) F1.g (3.1 (k))	HDD SDD Additional memory Additional buffered DDF Additional I/O devices  maximum power (in Watts and rounde operating condition c) (as defined in Table 6)	No #: 3   Yes #: 2   No #: 0   Yes #: 252   R channel	No Allowance 2,0 W/Active Port and < 10 Gb/s: 4,0 W/Active Port and < 50Gb/s: 15,0 W/Active Port and < 50Gb/s: 20,0 W/Active Port 26,0 W/Active Port standard or low-end performanconfiguration: A1 A2 A3 A4  Exception comments	Yes #: 3	
F1.f (3.1 (j)) F1.g (3.1 (k))	HDD SDD Additional memory Additional buffered DDF Additional I/O devices  maximum power (in Watts and rounded operating condition of (as defined in Table of idle state power at the sta	No #: 3   Yes #: 2   No #: 0   Yes #: 252   No #: 0     No #: 0     No #: 0	No Allowance 2,0 W/Active Port and < 10 Gb/s: 4,0 W/Active Port and < 25Gb/s: 15,0 W/Active Port and < 50Gb/s: 20,0 W/Active Port 26,0 W/Active Port standard or low-end performar configuration: A1 A2 A3 A4  Exception comments standard or low-end performar	Yes #: 3  No #: 0  Yes #: 2  Yes #: 2044GB  No #: 8  □ none □ <1 Gb/s: No Allowance □ =1 Gb/s: 2,0 W/Active Port □ >1 Gb/s and <10 Gb/s: 4,0 W/Active Port □ ≥ 10 Gb/s and < 25Gb/s: 15,0 W/Active Port □ ≥ 25 Gb/s and < 50Gb/s: 20,0 W/Active Port □ ≥ 50 Gb/s 26,0 W/Active Port nce high-end performance configuration: 1024.7  nce high-end performance configuration: □ A1 □ A2 □ A3 □ A4  Exception comments  nce high-end performance	
F1.f (3.1 (j)) F1.g (3.1 (k)) F1.h (3.1 (l))	HDD SDD Additional memory Additional buffered DDF Additional I/O devices  maximum power (in Watts and rounder operating condition of (as defined in Table of the declared operating operating condition of (as defined in Table of the declared operating operating condition of (as defined in Table of the declared operating condition of (as defined in Table of the declared operating condition	No #: 3   Yes #: 2   No #: 0   Yes #: 252   No #: 0     No #: 0     No #: 0	No Allowance 2,0 W/Active Port and < 10 Gb/s: 4,0 W/Active Port and < 25Gb/s: 15,0 W/Active Port and < 50Gb/s: 20,0 W/Active Port 26,0 W/Active Port standard or low-end performar configuration: 334.4 standard or low-end performar configuration:  A1 A2 A3 A4  Exception comments  standard or low-end performar configuration:  209.1	Yes #: 3  No #: 0  Yes #: 2  Yes #: 2044GB  No #: 8  □ none □ <1 Gb/s: No Allowance □ =1 Gb/s: 2,0 W/Active Port □ >1 Gb/s and <10 Gb/s: 4,0 W/Active Port □ ≥25 Gb/s and <50Gb/s: 20,0 W/Active Port □ ≥50 Gb/s 26,0 W/Active Port □ ≥ 50 Gb/s 26,0 W/Active Port □ ≥ 10 Gb/s and < 10 Gb/s: 15,0 W/Active Port □ ≥ 10 Gb/s and <10 Gb/s: 20,0 W/Active Port □ ≥ 10 Gb/s and <10 Gb/s: 20,0 W/Active Port □ ≥ 10 Gb/s and <10 Gb/s: 20,0 W/Active Port □ ≥ 10 Gb/s: 20,0 W/Active Port □ ≥ 25 Gb/s: 20,0 W/Active Port □ ≥ 2	
F1.f (3.1 (j)) F1.g (3.1 (k))	HDD SDD Additional memory Additional buffered DDF Additional I/O devices  maximum power (in Watts and rounder operating condition of (as defined in Table of the declared operating operating condition of (as defined in Table of the declared operating operating condition of (as defined in Table of the declared operating condition of (as defined in Table of the declared operating condition	No #: 3   Yes #: 2   No #: 0   Yes #: 252   No #: 0     No #: 0     No #: 0	No Allowance 2,0 W/Active Port and < 10 Gb/s: 4,0 W/Active Port and < 25Gb/s: 15,0 W/Active Port and < 50Gb/s: 20,0 W/Active Port 26,0 W/Active Port standard or low-end performar configuration: A1 A2 A3 A4  Exception comments standard or low-end performar	Yes #: 3  No #: 0  Yes #: 2  Yes #: 2044GB  No #: 8  none <pre></pre>	